TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

# **T2N7002AK**

## O High Speed Switching Applications

· ESD protected gate

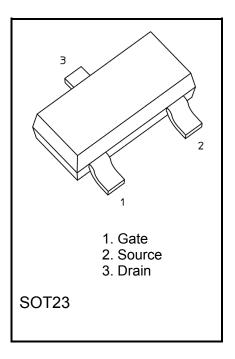
• Low ON-resistance  $R_{DS(on)} = 2.8 \Omega \text{ (typ.) } (@V_{GS} = 10 \text{ V})$ 

 $R_{DS(on)} = 3.1 \Omega \text{ (typ.) } (@V_{GS} = 5 \text{ V})$ 

 $R_{DS(on)} = 3.2 \Omega \text{ (typ.) } (@V_{GS} = 4.5 \text{ V})$ 

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic		Symbol	Rating	Unit	
Drain-source voltage	$V_{DSS}$	60	V		
Gate-source voltage	$V_{GSS}$	± 20	V		
Drain current (Note1)	DC	I <sub>D</sub>	200	mA	
Diain current (Note i)	Pulse	I <sub>DP</sub> (Note 2)	760		
Dower dissination	P <sub>D</sub> (Note 3)	320	mW		
Power dissipation		P <sub>D</sub> (Note 4)	1000		
Channel temperature	T <sub>ch</sub>	150	°C		
Storage temperature	T <sub>stg</sub>	−55 to 150	°C		



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: The channel temperature should not exceed 150°C during use.

Note 2: Pulse width ≤ 10 µs, Duty ≤ 1%

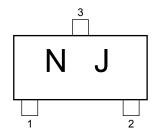
Note 3: Mounted on an FR4 board

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{ Cu Pad: } 0.42 \text{ mm}^2 \text{ x 3})$ 

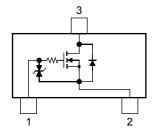
Note 4: Mounted on an FR4 board

(25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm, Cu Pad: 645 mm $^2$ )

#### Marking



## **Equivalent Circuit (top view)**



Start of commercial production 2015-01

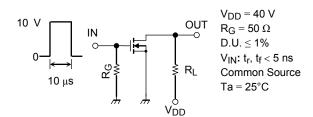
# **Electrical Characteristics (Ta = 25°C, Otherwise specified)**

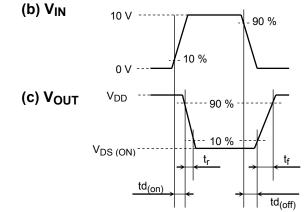
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-source b	oreakdown voltage	V <sub>(BR) DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	60	_	_	V
Drain cutoff current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	1	μА	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, \text{ Tj=150 °C}$	_	_	200	μΑ	
		I <sub>GSS</sub>	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±2	μА
Gate leakage current	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±0.5		
	$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0 \text{ V}$		_	_	±0.1		
Gate threshold	l voltage	V <sub>th</sub>	$I_D = 250 \mu A, V_{DS} = V_{GS}$	1.1	_	2.1	V
Forward transf	er admittance	Y <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 200 \text{ mA}$ (Note 5)	_	450	_	mS
	R <sub>DS</sub> (ON) (Note 5)	$I_D = 100 \text{ mA}, V_{GS} = 10 \text{ V}$	_	2.8	3.9	Ω	
Drain-source ON-resistance		I <sub>D</sub> = 100 mA, V <sub>GS</sub> = 10 V, Tj=150 °C	_	5.4	8.1		
		I <sub>D</sub> = 100 mA, V <sub>GS</sub> = 5 V	_	3.1	4.4		
		I <sub>D</sub> = 100 mA, V <sub>GS</sub> = 4.5 V	_	3.2	4.7		
Total Gate Charge Gate-Source Charge Gate-Drain Charge		Q <sub>G(tot)</sub>	V 00 V 1 000 A	_	0.27	0.35	nC
		Q <sub>GS</sub>	$V_{DS} = 30 \text{ V, I}_{D} = 200 \text{ mA}$	_	0.08	_	
		$Q_{GD}$	V <sub>GS</sub> = 4.5 V	_	0.08	_	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	11	17	pF
Output capacitance		C <sub>oss</sub>		_	3	_	
Reverse transfer capacitance		C <sub>rss</sub>		_	0.7	_	
Switching time	Turn-on delay time	t <sub>d(on)</sub>		_	2	4	ns
	Rise time	t <sub>r</sub>	$V_{DD}$ = 40 V, $I_D$ = 160 mA $V_{GS}$ = 0 V to 10 V, $R_G$ = 50 $\Omega$	_	3	_	
	Turn-off delay time	t <sub>d(off)</sub>		_	7	14	
	Fall time	t <sub>f</sub>		_	24	_	
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = -115 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note 5)	_	-0.87	-1.2	V

Note 5: Pulse test

### **Switching Time Test Circuit**

#### (a) Test Circuit



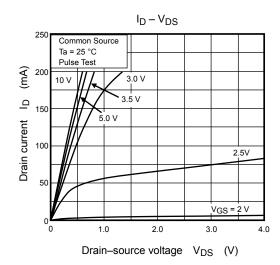


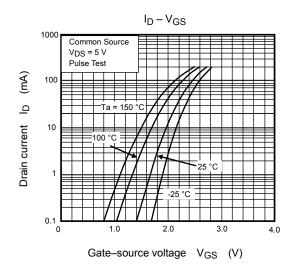
### **Notice of Usage**

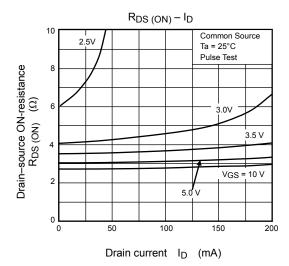
Let  $V_{th}$  be the voltage applied between gate and source that causes the drain current (ID) to below (0.25 mA for this device). Then, for normal switching operation,  $V_{GS(ON)}$  must be higher than  $V_{th}$ , and  $V_{GS(OFF)}$  must be lower than  $V_{th}$ . This relationship can be expressed as:  $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$ . Take this into consideration when using the device.

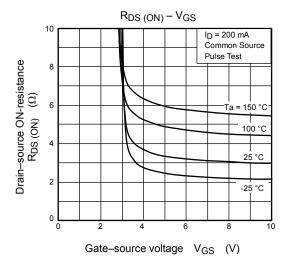
#### **Handling Precaution**

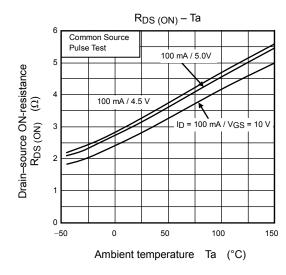
The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

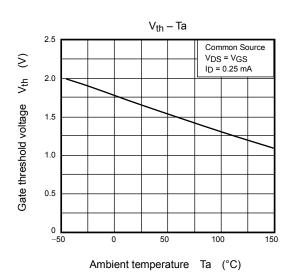


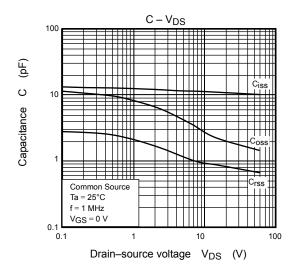


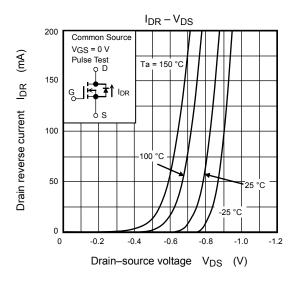


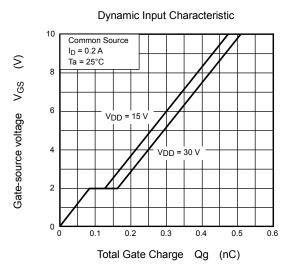


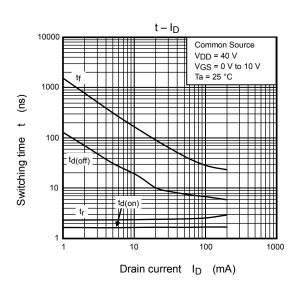


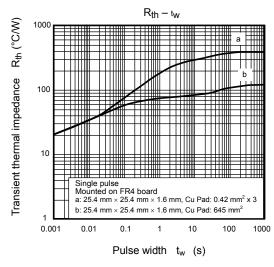


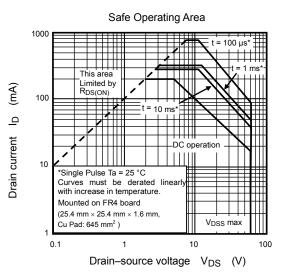












Note: The above characteristics curves are presented for reference only and not guaranteed by production test.

5 2015-04-01



# **Package Dimensions**

Unit: mm SOT23 0.15 <del>+0.1</del> -0.05  $2.9 \pm 0.1$ Α 3 2 1 0.4 +0.1 -0.05 <del>ф</del>0.10 (М) А 0.95 0.95 1.9 0.05 ±0.05  $0.9 \pm 0.1$ 

Weight: 0.009g (typ.)

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